S/N 10/081,818 PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Jerome M. Eldridge et al.

Examiner: Tu-Tu Ho

Serial No.:

10/081,818

Group Art Unit: 2818

Filed:

February 20, 2002

Docket No.: 1303.045US1

Customer No.: 73115

Confirmation No.: 3148

Title:

ATOMIC LAYER DEPOSITION OF METAL OXIDE AND/OR LOW

ASYMMETRICAL TUNNEL BARRIER INTERPLOY INSULATORS

COMMUNICATION RE: FEE ADDRESS

Mail Stop Issue Fee Commissioner for Patents P.O.Box 1450 Alexandria, VA 22313-1450

In response to the Notice of Allowance and Issue Fee Due, please record the Fee Address under the provisions of 37 CFR 1.363 as the following:

Customer Number 26809

which is associated with Micron Technology, Inc..

Please direct any inquiries to the undersigned attorney at (612) 349-9587.

Respectfully submitted,

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Nov. '08

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CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is filed using the USPTO's electronic filing system EFS-Web, and is addressed to: Mail Stop Issue Fee, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on this 4 day of November, 2008.

KATHLEEN E. KOTHROCK Name

Signature